Unit: mm

TOSHIBA Photocoupler GaAlAs Ired & Photo-Triac

# **TLP668J(S)**

Office Machine

Household Use Equipment

Triac Driver

Solid State Relay

The TOSHIBA TLP668J(S) consists of a zero voltage crossing turn-on photo-triac optically coupled to a GaAlAs infrared emitting diode in a six lead plastic DIP package.

- Peak off-state voltage: 600V (Min.)
- Trigger LED current: 3mA (Max.)
- On-state current: 100mA (Max.)
- Isolation voltage: 5000Vrms (Min.)
- UL recognized: UL1577, file No. E67349
- BSI approved: BS EN60065:2002, file No. 8385

BS EN60950-1:2002, file No. 8386

• SEMCO approved: EN60065, EN60950-1, EN60335-1

Certificate no.708960

Option(D4) type

VDE approved: DIN EN 60747-5-2

Certificate No. 40009302

Maximum operating insulation voltage : 890Vpk Highest permissible over voltage : 8000 Vpk

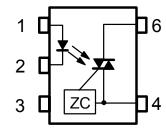
Weight: 0.39 g (Typ.)

(Note) When an EN60747-5-2 approved type is needed, please designate the "Option(D4)".

#### Construction mechanical rating

	7.62 mm pich standard type	10.16 mm pich TLPXXXF type
Creepage distance	7.0 mm (Min.)	8.0 mm (Min.)
Clearance	7.0 mm (Min.)	8.0 mm (Min.)
Insulation thickness	0.5 mm (Min.)	0.5 mm (Min.)

## Pin configuration (top view)



- 1: Anode
- 2: Cathode
- 3: N.C.
- 4:Terminal 1
- 6:Terminal 2

ZC:Zero-cross circuit

## **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic	Symbol	Rating	Unit	
ı ш 4 Forward current	lF	30	mA	

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	Characteristic	Symbol	Rating	Unit		
	Forward current derating (Ta≥25°C)	ΔI <sub>F</sub> /°C	-0.3	mA /°C		
	Peak forward current (100µs pulse, 100pps)	I <sub>FP</sub>	1	Α		
	Reverse voltage		V <sub>R</sub> 5		V	
Junction temperature				125	°C	
	Off-state output terminal voltage	$V_{DRM}$	600	V		
	On-state RMS current	Ta=25°C	l=(D) (O)	100	- mA	
'n	On-state RWS current	Ta=70°C	IT(RMS)	50		
Detector	On-state current derating (Ta≥25°C)	ΔI <sub>T</sub> /°C	-1.1	mA /°C		
Ŏ	Peak on-state current (100µs pulse, 120pps)	I <sub>TP</sub>	2	Α		
	Peak nonrepetitive surge current (Pw=10ms,DC=10%	I <sub>TSM</sub>	1.2	Α		
	Junction temperature	Tj	110	°C		
Оре	erating temperature range	T <sub>opr</sub>	-40~100	°C		
Stor	rage temperature range	T <sub>stg</sub>	T <sub>stg</sub> -55~125			
Lea	d soldering temperature (10s)	T <sub>sol</sub>	260	°C		
Isola	ation voltage (AC,1min. , R.H. ≤60%)	BVS	5000	Vrms		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 2) Device considered a two terminal device: Pins 1,2 and 3 shorted together and pin 4 and pin 6 shorted together.

### **Recommended Operating Conditions**

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V <sub>AC</sub>	_	_	240	Vac
Forward current	lF	4.5	6	7.5	mA
Peak on-state current	I <sub>TP</sub>	_	_	1	Α
Operating temperature	T <sub>opr</sub>	-10	-	85	°C

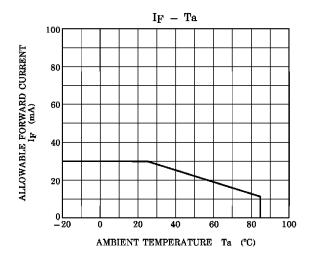
Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

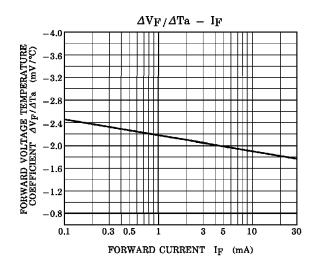
# **Electrical Characteristics (Ta = 25°C)**

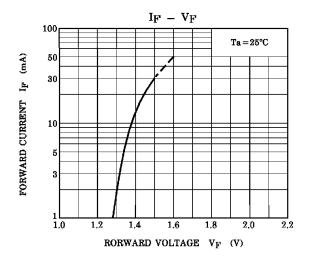
	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.2	1.4	1.7	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 3 V	1	1	10	μΑ
	Capacitance	C <sub>T</sub>	V = 0, f=1MHz	1	30	_	pF
	Peak off-state current	I <sub>DRM</sub>	V <sub>DRM</sub> =600V	_	10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> =100mA	_	_	3.0	V
Detector	Holding current	lΗ	_	_	0.6	_	mA
Det	Critical rate of rise of off-state voltage	dv/dt	Vin=240Vrms , Ta=85°C	200	500	_	V/µs
	Critical rate of rise of commutating voltage	dv/dt(c)	Vin=60Vrms , IT=15mA	_	0.2	_	V/µs

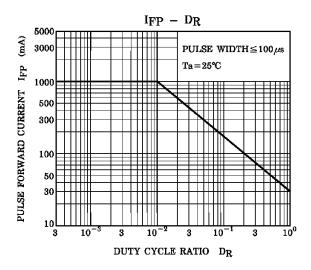
**Coupled Electrical Characteristics (Ta = 25°C)** 

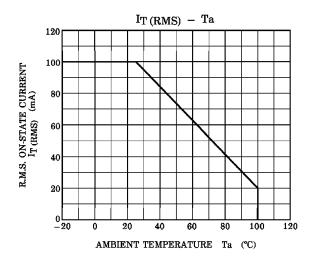
apiou Elouriou Griaractoriouso (14 – 25 s)							
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit	
Trigger LED current	I <sub>FT</sub>	V <sub>T</sub> =6V ,Resistive load	_	_	3	mA	
Inhibit voltage	V <sub>IH</sub>	I <sub>F</sub> =Rated I <sub>FT</sub>	_	_	50	V	
Leakage in inhibited state	lін	I <sub>F</sub> =Rated I <sub>FT</sub> , V <sub>T</sub> =rated V <sub>DRM</sub>	_	200	600	μA	
Capacitance (input to output)	CS	V <sub>S</sub> =0 , f=1MHz	_	0.8	_	pF	
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> =500V	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω	
	BVs	AC , 1minute	5000	_	_	Vrms	
Isolation voltage		AC , 1second,in oil	_	10000	_	VIIIIS	
		DC , 1minute,in oil	_	10000	_	Vdc	

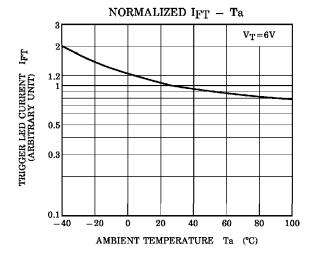


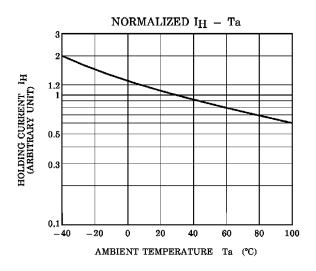


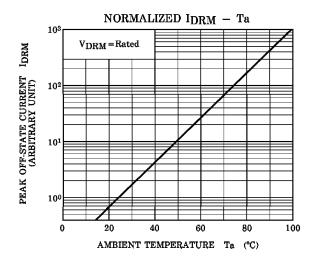


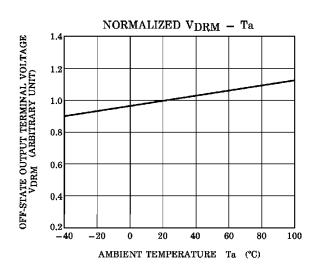


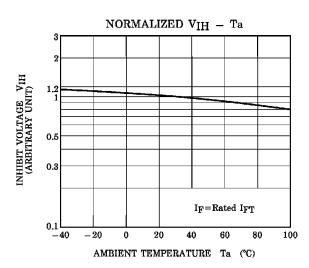


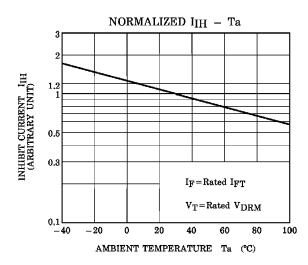












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